









## PRODUCT DATASHEET



- ► PTH Lamp
- ➤ 3mm Cylindrical 3.8t
- ▶ Blue (467nm)

NOBO8L69ZR (Bulk) NOB08L69ZRT (Taping)



# **3mm Cylindrical Lamp**





### **FEATURES:**

Package: PTH Lamp 3mm Cylindrical 3.8t

Forward Current: 20mA Forward Voltage (typ.): 3.1V

Luminous Intensity (typ.): 200mcd@20mA

Colour: Blue

Wavelength: 467nm Viewing angle: 150°

Electrostatics Discharge (ESD): 2000V

**Materials:** 

Die:InGaN

Resin: Epoxy (Water Clear)

Operating Temperature: -40~+85°C

Storage Temperature: -40~+100°C

**Grouping parameters:** 

Forward voltage

Luminous intensity

Wavelength

Soldering methods: Hand; Wave Soldering (DIP)

Preconditioning: acc. to JEDEC Level 3

Packing: 500pcs/Bulk; 2000pcs/Taping

3 mm Cylindrical Lamp

#### **APPLICATIONS:**

- Indicator
- Switch
- Signal Light



#### **CHARACTERISTICS:**

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I <sub>F</sub>	30	mA
Peak Forward Current Duty 1/10@1KHz	I <sub>FP</sub>	100	mA
Reverse Current @5V	I <sub>R</sub>	10	μΑ
Power Dissipation	P <sub>D</sub>	85	mW
Electrostatics Discharge	ESD	2000	V
Operating Temperature	T <sub>OPR</sub>	-40~+85	°C
Storage Temperature	T <sub>STG</sub>	-40~+100	°C

## Electrical & Optical Characteristics (Ta=25°C)

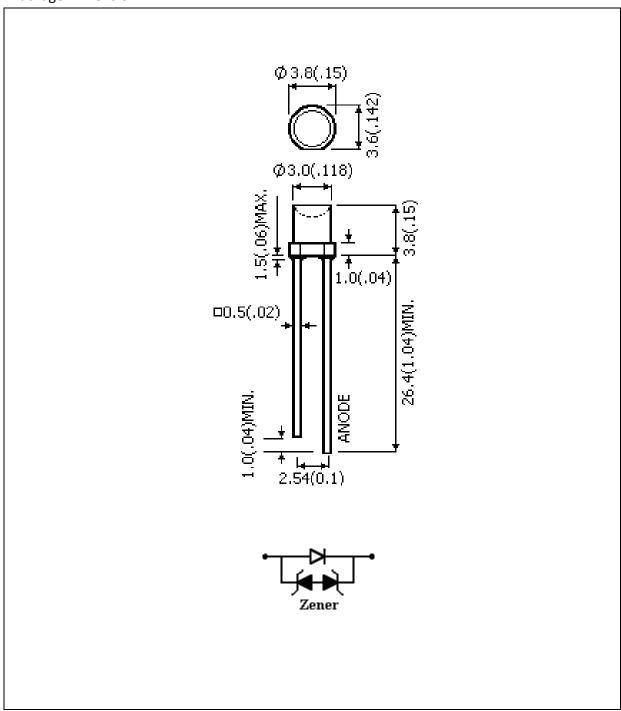
Parameter Symbol		Values			Unit	Test
Parameter Symb	Зуппоп	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	$V_{F}$	2.8	3.1	3.5	V	I <sub>F</sub> =20mA
Luminous Intensity	I <sub>V</sub>	150	200	250	mcd	I <sub>F</sub> =20mA
Dominant Wavelength	$\lambda_{\scriptscriptstyle D}$	464	467	471	nm	I <sub>F</sub> =20mA
Peak Wavelength	$\lambda_{P}$		470		nm	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>		150		deg	I <sub>F</sub> =20mA

<sup>1.</sup> Luminous intensity ( $I_V$ ) ±15%, Forward Voltage ( $V_F$ ) ±0.1V



## **OUTLINE DIMENSION:**

## Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.25mm, unless otherwise noted.



## **BINNING GROUPS:**

## Forward Voltage Classifications (I<sub>F</sub> = 20mA):

Code	Min.	Max.	Unit
V28	2.8	3.5	V

## Luminous Intensity Classifications ( $I_F = 20$ mA):

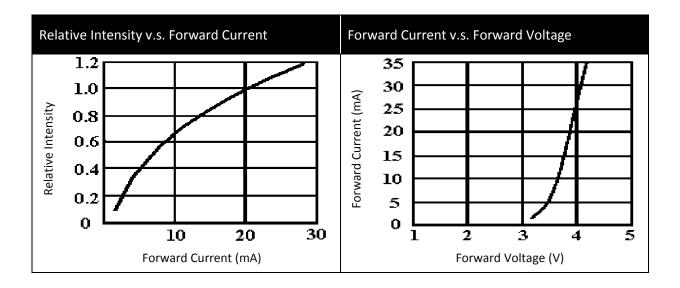
Code	Min.	Max.	Unit
L150	150	250	mcd

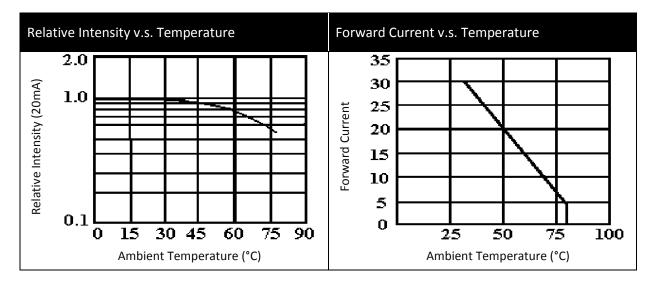
## Wavelength Classifications ( $I_F = 20 \text{mA}$ ):

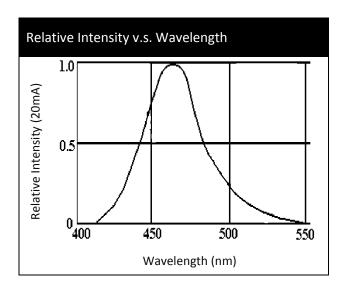
Code	Min.	Max.	Unit
B464	464	467	200
B467	467	471	nm



#### **ELECTRO-OPTICAL CHARACTERISTICS:**







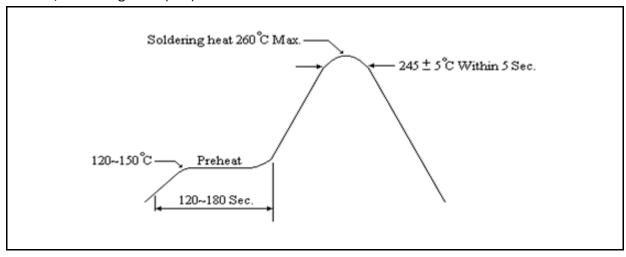


#### **RECOMMENDED SOLDERING PROFILE:**

## Hand Solder (Solder Iron):

- Temperature at tip of iron: 300°C Max. (25W Max.).
- Soldering Time: 3 seconds ± 1 sec.
- Maximum reflow soldering: 1 time.

#### Wave / Soldering Heat (DIP):



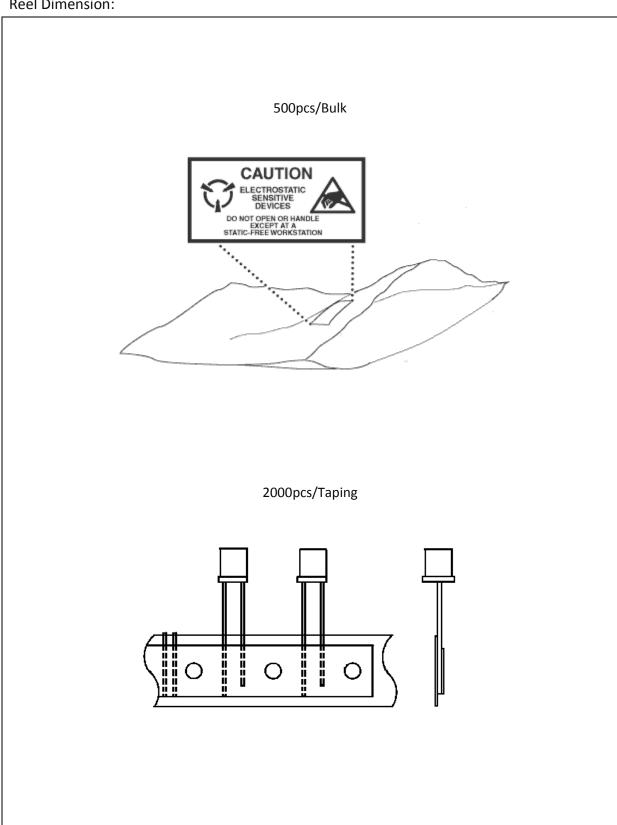
#### Note:

- 1. Maximum reflow soldering: 1 time.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.



## **PACKING SPECIFICATION:**

#### Reel Dimension:





#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

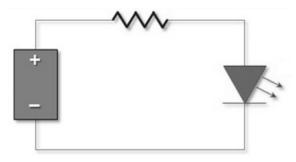
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



## **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	04/08/2015	Datasheet set-up.
A1.1	21/09/2015	Update solder profile.